

N-channel MOSFET

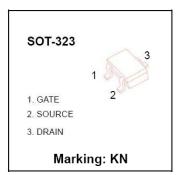
FEATURES

- Low on-resistance
- Fast switching speed
- · Low voltage drive makes this device ideal for portable equipment
- Easily designed drive circuits
- Easy to parallel
- ESD Protect

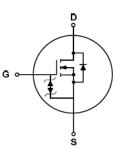
MOSFET MAXIMUM RATINGS (T_a = 25°C unless otherwise noted)

Symbol	Parameter	Value	Units
VDs	Drain-Source voltage	30	V
Vgss	Gate-Source Voltage	±20	V
D	Continuous Drain Current	0.1	А
PD	Power Dissipation	0.2	W
TJ	Junction Temperature	150	°C
Tstg	Storage Temperature	-55-150	°C
RθJA	Thermal Resistance from Junction to Ambient	625	°C /W

2SK3018W





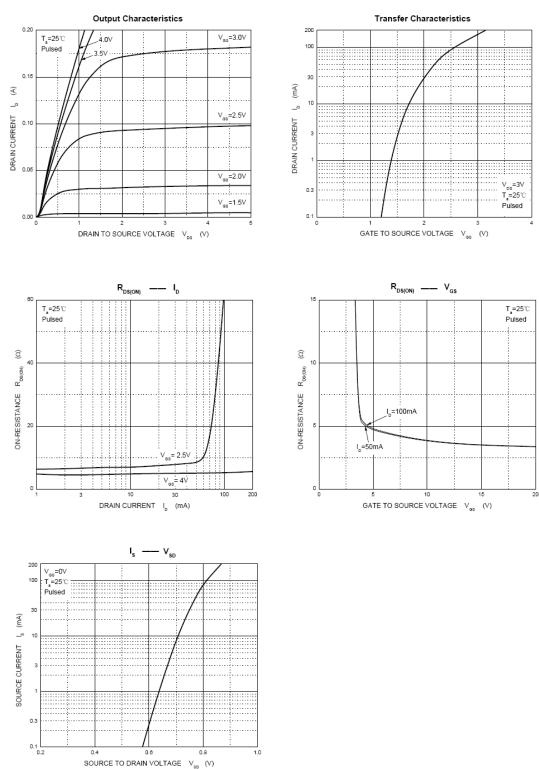


MOSFET ELECTRICAL CHARACTERISTICS(Ta=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Off Characteristics			_			
Drain-Source Breakdown Voltage	V(BR)DSS	V_{GS} = 0V, I _D = 10 μ A	30			V
Zero Gate Voltage Drain Current	IDSS	VDS =30V,VGS = 0V			0.2	μA
Gate –Source leakage current	lgss	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±10	μΑ
Gate Threshold Voltage	VGS(th)	V _{DS} = 3V, I _D =100µA	0.8		1.5	V
Drain-Source On-Resistance	RDS(on)	Vgs = 4V, Id =10mA			8	Ω
Drain-Source On-Resistance		Vgs =2.5V,Ip =1mA			13	Ω
Forward Transconductance	g fs	Vps =3V, Ip = 10mA	20			mS
Dynamic Characteristics*				•		•
Input Capacitance	Ciss			13		pF
Output Capacitance	Coss VDS =	V _{DS} =5V,V _{GS} =0V,f =1MHz		9		pF
Reverse Transfer Capacitance	Crss			4		pF
Switching Characteristics*			•	•		
Turn-On Delay Time	td(on)			15		ns
Rise Time	tr	Vgs =5V, Vdd =5V,		35		ns
Turn-Off Delay Time	td(off)	I⊳ =10mA, Rg=10Ω, R∟=500Ω		80		ns
Fall Time	tr	Ť		80		ns



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单击下面可查看定价,库存,交付和生命周期等信息

>>SHIKUES(时科)